

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPD65R225C7	**Issued**	27. April 2022
MA#	MA005732532		
Package	PG-TO252-3-35	**Weight***	323.97 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.621	1.12	1.12	11176	11176
leadframe	inorganic material	phosphorus	7723-14-0	0.053	0.02		164	
	non noble metal	iron	7439-89-6	0.177	0.05		547	
	non noble metal	copper	7440-50-8	176.899	54.61	54.68	546039	546750
wire	non noble metal	aluminium	7429-90-5	2.275	0.70	0.70	7024	7024
encapsulation	organic material	carbon black	1333-86-4	0.402	0.12		1240	
	plastics	epoxy resin	-	15.664	4.84		48350	
	inorganic material	silicondioxide	60676-86-0	117.813	36.37	41.33	363657	413247
leadfinish	non noble metal	tin	7440-31-5	3.834	1.18	1.18	11833	11833
solder	non noble metal	tin	7440-31-5	0.065	0.02		199	
	noble metal	silver	7440-22-4	0.081	0.02		249	
	non noble metal	lead	7439-92-1	3.085	0.95	0.99	9522	9970
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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